L1	145	(US-4092697-$ or US-4561011-$ or US-4612601-$ or US-4628990-$ or US-4654966-$ or US-4744007-$ or US-4949219-$ or US-5067007-$ or US-5108955-$ or US-5126829-$ or US-5151773-$ or US-5168348-$ or US-5276289-$ or US-5276586-$ or US-5306948-$ or US-5311402-$ or US-5329160-$ or US-5345107-$ or US-5349831-$ or US-5396403-$ or US-5430611-$ or US-5468910-$ or US-5471027-$ or US-5476818-$ or US-5510956-$ or US-5587882-$).did. or (US-5594282-$ or US-5604978-$ or US-5616957-$ or US-5619070-$ or US-5623394-$ or US-5650918-$ or US-5655290-$ or US-5705850-$ or US-5705851-$ or US-5724729-$ or US-5726079-$ or US-5736785-$ or US-5744752-$ or US-5745344-$ or US-5751062-$ or US-5757620-$ or US-5777847-$ or US-5819402-$ or US-5834327-$ or US-5844311-$ or US-5881944-$ or US-5881945-$ or US-5883425-$ or US-5889323-$ or US-5898224-$ or US-5904497-$ or US-5907474-$).did. or (US-5920120-$ or US-5926371-$ or US-5931222-$ or US-5950073-$ or US-5956576-$ or US-5977626-$ or US-5981310-$ or US-5982038-$ or US-5982621-$ or US-5990418-$ or US-6008536-$ or US-6025995-$ or US-6046498-$ or US-6064217-$ or US-6082443-$ or US-6091603-$ or US-6111322-$ or US-6114761-$ or US-6124636-$ or US-6140707-$ or US-6146921-$ or US-6163458-$ or US-6165820-$ or US-6166435-$ or US-6184580-$ or US-6191360-$ or US-6208519-$).did. or (US-6214647-$ or US-6215180-$ or US-6218730-$ or US-6255143-$ or US-6265769-$ or US-6265771-$ or US-6271058-$ or US-6275381-$ or US-6281573-$ or US-6281575-$ or US-6282096-$ or US-6288900-$ or US-6292369-$ or US-6294408-$ or US-6304450-$ or US-6320257-$ or US-6344682-$ or US-6351032-$ or US-6369455-$ or US-6373133-$ or US-6380621-$ or US-6396701-$ or US-6400014-$ or US-6410981-$ or US-6411507-$ or US-6413353-$ or US-6414385-$).did. or (US-6429513-$ or US-6433420-$ or US-6437740-$ or US-6441499-$ or US-6444496-$ or US-6451155-$ or US-6459160-$ or US-6469380-$	USPAT	OR	ON	2005/02/21 13:17

L2	137	1 and (pcb substrate ((circuit wiring) near1 board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:16
L3	41	2 and (grounding grounded ground)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:17
L4	92	2 and (power grounding grounded ground)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 13:18
L5	2244704	(pcb substrate ((circuit wiring) near1 board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:17
L6	225712	5 and (grounding grounded ground)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:22
L7	25142	5 and ((grounding grounded ground) near1 (layer plane))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:23
L8	11508	shielding near1 electromagnetic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:24
L9	12156	(shielding shielded) near1 electromagnetic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:24
L10	561	7 and 9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:25
L11	90913	heatsink (heat adj sink) (heat adj dissipating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:26

L12	105	10 and 11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:26
L13	99	12 and (chip die (integrated adj circuit) ((semiconductor electronic) near1 device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/21 14:27
L14	0	("6643137").URPN.	USPAT	OR	ON	2005/02/21 14:31
L15	9	("6071128" | "6075700" | "6205026" | "6226185" | "6296520" | "6362977" | "6377474" | "6442045" | "6473305").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:31
L16	147	("5371404").URPN.	USPAT	OR	ON	2005/02/21 14:40
L17	11	("5311059" | "5371404" | "5977626" | "6255140" | "6432742" | "6437437" | "6469381" | "6519154" | "6525420" | "6538319" | "6566748").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:44
L18	4	("6487077").URPN.	USPAT	OR	ON	2005/02/21 14:49
L19	4	("4970579" | "5371404" | "6008991" | "6093961").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:49
L20	33	("5909057").URPN.	USPAT	OR	ON	2005/02/21 14:51
L21	10	("5367193" | "5789810" | "5905636" | "5909057" | "5926371" | "6069023" | "6175500" | "6255140" | "6411507" | "6504243").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:52
L22	17	("4004195" | "4323914" | "5006922" | "5019673" | "5103292" | "5291064" | "5311059" | "5371404" | "5409865" | "5525835" | "5561323" | "5570272" | "5572070" | "5721451" | "5737191" | "5744863" | "5789809").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:56
L23	10	("5589711").URPN.	USPAT	OR	ON	2005/02/21 14:58
L24	9	("3911327" | "3946276" | "4415025" | "4593342" | "4807019" | "5175613" | "5305185" | "5371404" | "5375652").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 14:59
L25	48	("5175613").URPN.	USPAT	OR	ON	2005/02/21 15:00

L26	3	("5175613" | "5541811" | "6084178").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:01
L27	16	("4217684" | "4233645" | "4251852" | "4442450" | "4514752" | "4561011" | "4599680" | "4612601" | "4680617" | "4680676" | "4715115" | "4736266" | "4754101" | "4812949" | "4829432" | "5043534").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:03
L28	15	("2967984" | "3280019" | "3439255" | "3564109" | "3777221" | "4177480" | "4278991" | "4811081" | "4825284" | "5113241" | "5175613" | "5218234").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:04
L29	4	("6166435").URPN.	USPAT	OR	ON	2005/02/21 15:07
L30	3	("5153379" | "5917702" | "5977626").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:08
L31	29	("5153379").URPN.	USPAT	OR	ON	2005/02/21 15:09
L32	1	("4967315").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:10
L33	3	("5153379" | "5917702" | "5977626").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:11
L34	1	("5844311").URPN.	USPAT	OR	ON	2005/02/21 15:11
L35	6	("4853762" | "4949219" | "4975766" | "5276289" | "5329160" | "5455457").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:11
L36	123	("4092697").URPN.	USPAT	OR	ON	2005/02/21 15:12
L37	3	("3616533" | "3673306").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/21 15:14